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(54) Title: HIGH PRESSURE SEAL ADAPTER FOR SPLITTER CONDUCTOR HOUSING TO WELLHEAD CONNECTION

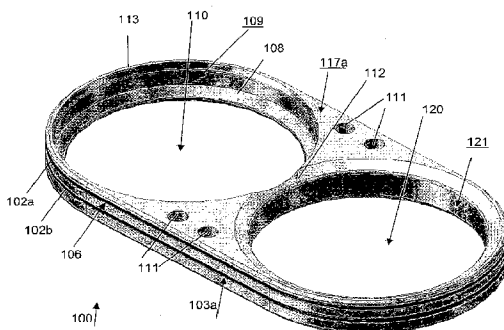


Figure 4

(57) Abstract: A high pressure seal adapter for a conductor housing of a wellhead, the high pressure seal adapter having a unitary body comprising: a first circular bore extending through said unitary body; and a second circular bore adjacent said first circular bore and extending through said unitary body; wherein said seal adapter is capable of being installed in said conductor housing. The high pressure seal adapter may further include at least one seal extending around a perimeter of said unitary body, said at least one seal contacting said conductor housing. The adapter may receive a high pressure riser in said first circular bore when said seal adapter is installed in said conductor housing, said high pressure riser having a lower surface that contacts said flange and at least one seal extending around an outside perimeter of said riser.



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